

Space Station Cable/Wire Design and Control Requirements for Electromagnetic Compatibility

International Space Station

Revision E

22 December 1998



NASDA

National Space Development
Agency of Japan



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(Italian Space Agency)

National Aeronautics and Space Administration
Space Station Program Office
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INTERNATIONAL SPACE STATION PROGRAM
SPACE STATION CABLE/WIRE DESIGN AND CONTROL REQUIREMENTS FOR
ELECTROMAGNETIC COMPATIBILITY

22 DECEMBER 1998

PREFACE

This document contains wiring and cabling requirements for electromagnetic compatibility. The contents of this document are intended to be consistent with requirements as defined in the SSP 41000 and SSP 30243. Space Station Cable/Wire Design and Control Requirements for Electromagnetic Compatibility shall be implemented on all SSP contractual and internal activities. This document is under control of the Space Station Control Board.

INTERNATIONAL SPACE STATION PROGRAM OFFICE
SPACE STATION CABLE/WIRE DESIGN AND CONTROL REQUIREMENTS FOR
ELECTROMAGNETIC COMPATIBILITY

22 DECEMBER 1998

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INTERNATIONAL SPACE STATION PROGRAM

**SPACE STATION ELECTROMAGNETIC CABLE/WIRE DESIGN AND CONTROL
REQUIREMENTS FOR ELECTROMAGNETIC COMPATIBILITY**

22 DECEMBER 1998

For NASA

DATE

For ASI

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NASA/CSA

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ESA Concurrence:
Reference SSP 50019 Joint Management Plan and
JESA 30000, Section 3, Appendix B

DATE

NASA/NASDA

INTERNATIONAL SPACE STATION PROGRAM

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**INTERNATIONAL SPACE STATION PROGRAM
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**LIST OF CHANGES
22 DECEMBER 1998**

All changes to paragraphs, tables, and figures in this document are shown below:

| SSCBD | ENTRY DATE | CHANGE | PARAGRAPH(S) |
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1.0 GENERAL

1.1 INTRODUCTION

Wiring and cabling carrying electrical signals will couple those signals to other wires and cables. Wire and cable separation and shielding treatment can be used to reduce the coupling effects and the resulting undesirable circuit effects. Design analysis, maintenance and correction of problems cannot be implemented without identification of wire and cable bundles and routing. This document identifies requirements for wire and cable signal classification, signal separation, and identification.

1.2 SCOPE

This document defines wiring and cabling requirements for Electromagnetic Compatibility in accordance with the specifications of SSP 30243. The requirements of this document are applicable to all flight elements of the Space Station Program (SSP) and to all equipment at the interface with flight elements.

1.3 PURPOSE

The purpose of this document is to provide a uniform specification and methodology for cabling and wiring requirements for EMC. These requirements will minimize the effect of magnetic and/or electric field coupling between the wiring and circuits associated with the wiring.

1.4 PRECEDENCE

SSP 30243 invokes this document for cable/wire design and control requirements for EMC. In the event of any conflict between this document and any other document, SSP 30243 shall take precedence.

2.0 APPLICABLE DOCUMENTS

The following applicable documents of the exact issue shown in the current issue of SSP 50257 form a part of this specification to the extent specified in the referenced paragraphs. Inclusions of applicable documents does not supersede the order of precedence identified in 1.4.

| DOCUMENT NO. | TITLE |
|---------------------|--|
| SSP 30240 | Space Station Grounding Requirements Reference paragraphs 3.1 and 3.2.2.1.3 |
| SSP 30243 | Space Station Requirements for Electromagnetic Compatibility Reference paragraphs 1.2, 1.4, 3.1, 3.2.2, and 3.2.2.3.2 |
| SSP 41173 | Space Station Quality Assurance Requirements Reference paragraph 4.0 |

2.1 REFERENCE DOCUMENTS

| DOCUMENT NO. | TITLE |
|---------------------|--------------|
|---------------------|--------------|

The following documents are referenced in this specification as a guide for context and user convenience. The references to these documents are not listed in SSP 50257.

| | |
|-----------|---|
| SSP 30245 | Space Station Electrical Bonding Requirements Reference paragraph 3.1 |
| SSQ 21654 | Cable, Single Filter, Multimode, Space Quality, General Specification Reference paragraph 3.1 |

3.0 REQUIREMENTS

3.1 CABLE/WIRE DESIGN DEFINITION FOR ELECTROMAGNETIC COMPATIBILITY

The use of fiber-optic cables for signal transmission is recommended to reduce electromagnetic noise coupling problems. The requirements for fiber-optic cables are contained in SSQ 21654. The reduction of electromagnetic effects in the wiring will be accomplished by isolating incompatible circuits via wire cable bundling, routing, shielding, separation, and wire treatment requirements presented herein. All external interface circuits and electrical or electronic equipment will be evaluated and will receive an Electromagnetic Environment Effects Control (EMEEC) classification based upon the following circuit parameters. The approach to cable design including wiring/cable classifications, shielding, and routing will be included in the Electromagnetic Effects (EME) Control Plan as specified in SSP 30243. The classification designations, i.e., ML, EO, HO, and MO, are arbitrary and have no implied meanings. Bonding and grounding will be in accordance with SSP 30245 and SSP 30240.

3.2 CHARACTERISTICS

3.2.1 CIRCUIT CLASSIFICATION

The following criteria shall be applied to determine the appropriate EMEEC circuit classification for each circuit. See appendix C for the exception (EMECB TIA-0066) to this paragraph.

3.2.1.1 FREQUENCY OR RISE/FALL TIME

For Table 3.2.1.1-1 classification purposes, the fundamental component of steady state operation shall determine the frequency of the circuit unless the rise/fall time (pulsed wave forms) is less than 10 microseconds. If the rise/fall time is less than 10 microseconds and the voltage is less than 6 volts, the circuit shall be classified as Radio Frequency (RF) regardless of the fundamental frequency. Power circuits which are switched on and off shall be classified as HO or EO even if their rise/fall times are less than 10 microseconds. See appendix C for exception (EMECB TIA-0087) to this paragraph.

TABLE 3.2.1.1-1 EMC CLASSIFICATION, WIRE TYPE, AND SHIELD GROUNDING

| Frequency f: Rise, Fall Time (ms) t_r , t_f | Voltage or Sensitivity | Load Impedance (ohms) | Circuit Class | Minimum Wire Type | Shield Ground ¹ |
|--|---|--|---------------|-------------------------|-------------------------------|
| Analog (ac, dc) $f \leq 50\text{kHz}$ $t_r, t_f > 10\mu\text{s}$ | $\leq 100\text{mV}$ | $< 600\text{ k}$ | ML | TWS | MPG |
| | $\leq 100\text{mV}$ | $\geq 600\text{ k}$ | ML | TWDS | MPG |
| | $< 6\text{V}$ | All | ML | TWS | MPG |
| | $6-40\text{V}$ $> 40\text{V}$ | All All | HO EO | TW TW | None None |
| $50\text{kHz} > f$ $\leq 4\text{MHz}$ t_r , $t_f \leq 10\mu\text{s}$ | $< 100\text{mV}$ | All | RF | TWDS | MPG |
| | $> 100\text{mV}$ | All | RF | TWS | MPG |
| $f > 4\text{MHz}^1$ | All | All | RF | TWS, Coax or Twin-ax | MPG |
| BWAD Fiber Optics | All | All | MO FO | TWS Fiber Optics | MPG |
| Acronyms and Abbreviations: | ML, HO, EO, MO FO MPG RF TW TWDS TWS | Arbitrary Nomenclature to define circuit Classification Multiple Point Ground Radio Frequency Twisted Twisted Double Shielded Twisted Shielded | | | |
| Notes: | <ol style="list-style-type: none"> Shield grounding shall be compatible with the circuit application. The length of termination-to-ground lead for all circuits shall be the minimum length practical. The preferred method is to connect the shield peripherally to the back shell of the connector with a continuous impedance electrical bond path through both halves of the connector shell and the connector to mounting surface interface. Digital signals shall be classified as RF (and routed as wire type called out in this table). | | | | |

3.2.1.2 IMPEDANCE

The actual impedance of the interconnecting circuit, i.e., the complex “Z” that includes resistance, inductance and capacitance, shall be used to classify the source and load impedances using Table 3.2.1.1-1. These source and load impedances determine the magnetic and electric

field coupling mode category. The equivalent circuit pickup resistance, i.e., the sum of the load and equivalent reactive/resistive components, shall be used to identify potential areas for magnetic or electric field coupling.

3.2.1.3 VOLTAGE

The maximum peak-to-peak voltage appearing at the source of each circuit shall be used to determine the circuit classification using Table 3.2.1.1-1.

3.2.1.4 SENSITIVITY

If the interface circuit is susceptible to magnetic or electric field coupling that can cause induced noise with amplitudes less than the source voltage that will affect measurement and/or conversion accuracy, circuit classification shall be based upon circuit sensitivity considerations rather than upon frequency, rise/fall time, impedance, or voltage. Circuits assigned a classification based on sensitivity rather than on source voltage shall be identified on all wiring diagrams containing such circuits.

3.2.1.5 SIGNAL TYPE AND WIRE TYPE

Table 3.2.1.1-1 describes the classification of signal types and required wire type to control cable coupled interference. Cable and wire treatment shall be based on Table 3.2.1.1-1 and the wire/cable and isolation requirements.

3.2.2 CLASSIFICATION/WIRING PROCEDURE

The following requirements shall be applied to determine the classification of wiring treatment and installation of all interface circuit types:

STEP 1. Circuit Classification

To determine the appropriate EMEEC classification, the parameters of each subsystem equipment interface circuit shall be considered in the following order: (1) frequency or rise/fall times, (2) impedance, (3) voltage, and (4) sensitivity. Classification criteria are specified in Table 3.2.1.1-1. This classification shall appear on all wiring diagrams in which the circuit appears.

STEP 2. Determination of Interface Wiring Requirements

The appropriate wiring treatment shall be assigned to each circuit as required by the classification considerations applied in STEP 1. The wire type, twisting, shielding, and shield grounding requirements shall be reflected on all schematics, wiring diagrams, and interface control documents in which the circuit appears.

STEP 3. Bundling of All Coded Circuits

Circuits having different circuit classifications or redundancy codes and routed in the same area shall not be commonly bundled but may be routed in a common connector if a 20 dB coupling margin is maintained. Each bundle shall be coded with a bundle code which is the same as the circuit classification of the circuits which it contains. Each bundle classification shall be designated on drawings in which the bundle appears.

STEP 4. Redundancy Requirements

In cases where wiring redundancy is a requirement, separate cable bundles shall be formed. Such bundles shall be coded with the circuit classification code, plus a numeric designator code to identify the redundancy classification: ML-1, ML-2, EO-1, EO-2, etc.

STEP 5. Installation of Bundles

Cable/wire bundles installed in the Space Station Program flight elements shall use the 20 dB separation attenuation requirements of SSP 30243. Minimum edge-to-edge bundle separation requirements (in inches) for parallel runs of L feet shall be calculated. Separation requirements shall be determined by redundancy requirements or calculations based on analysis of signal and power parameters, circuit sensitivities, wire/cable design, etc., whichever is greater. Cable separation requirements and supporting analyses shall be documented in the EME Design Analysis Report.

3.2.2.1 DETERMINATION OF INTERFACE WIRING REQUIREMENTS

The following criteria shall be used to determine the wiring requirements for each circuit.

3.2.2.1.1 WIRE TYPE

The categorization of each circuit in terms of frequency, impedance, voltage or sensitivity to assure proper EMEEC classification shall permit the selection of wire type as specified in Table 3.2.1.1-1. The wire types given in Table 3.2.1.1-1 are general in nature and do not alleviate the responsible design groups from specifying the wire size, allowable capacitance, and attenuation characteristics. Specific details on selected wire types shall be included in applicable procurement specifications and assembly drawings.

3.2.2.1.2 SIGNAL TYPES REQUIRING CONTROLLED IMPEDANCE CHARACTERISTICS

Serial digital, data bus, video, and clock circuits operating below 4 megahertz (MHz) shall use controlled impedance wiring. RF circuits, including clock or data circuits with signal content of 4 MHz or above, shall use fiber-optic, twinaxial or triaxial cable to maintain the SSP requirements for isolation and single point references. Coaxial cable shall be permitted for signals with frequency content above 4 MHz where dc isolation is maintained.

3.2.2.1.3 SHIELD GROUNDING REQUIREMENTS

Shields shall be terminated at both ends and at intermediate break points directly to structure or chassis, through connector backshells or direct wire connection per the methodology specified in SSP 30240.

3.2.2.2 IMPLEMENTATION OF CODING AND BUNDLING

All circuits routed together in a bundle shall be of the same classification. Circuits classified by sensitivity shall be analyzed to determine if the source voltage will be detrimental to other circuits in the bundle and if it is necessary to isolate such circuit wiring from other wires in the classification. See appendix C for exception (EMECB TIA-0113) to this paragraph.

3.2.2.3 IMPLEMENTATION OF BUNDLE INSTALLATION

The bundles which have been formed and coded shall be installed using the following requirements to provide the required electrical isolation between different signal levels.

3.2.2.3.1 PHYSICAL ISOLATION OF BUNDLES WITH DIFFERENT CODES

Each bundle type shall be physically isolated from all other bundles of a different bundle code. This separation provides electromagnetic coupling isolation between unlike bundles and circuits carrying different redundancy codes.

3.2.2.3.2 SEPARATION REQUIREMENTS

Each bundle type of one code shall be physically separated from other bundles to meet the 20 dB isolation requirement of SSP 30243. Metallic channel separation shall be permitted in lieu of physical separation, provided that the channel separator height is no less than the largest cable bundle diameter requiring separation and that analysis shows that the channels provide the required 20 dB isolation. The application of such metallic barriers in lieu of physical separation shall be identified on all wiring diagrams containing these circuits. Cable bundle placement in all wire trays shall also be determined using minimum-to-maximum voltage or sensitivity requirements of Table 3.2.1.1-1, e.g., EO and RF cable bundles shall have maximum separation in the placement of adjacent wire bundles. See appendix C for exception (EMECB TIA-0113) to this paragraph.

3.2.2.4 SHIELDS

Shielding within a flight element shall be identified in the EME Design Analysis report. System interconnections shall terminate overall cable shields peripherally.

3.2.2.4.1 TERMINATIONS

Radio Frequency Interference (RFI) backshells with individual shield grounding provisions shall be used for multiple RF shield terminations. The length of the termination-to-ground lead for RF circuits shall be the minimum practical and shall not exceed 3 inches. The preferred method is to connect the shield peripherally to the backshell of an RF connector. This requires a continuous low-impedance electrical bond path through both halves of the connector shell, the connector-to-chassis interface, and the chassis-to-ground. All electrical connectors not engaged during mission shall be covered with a conductive cap. High impedance wires shall be terminated with a low impedance. See appendix C for exception (EMECB TIA-0086) to this paragraph.

3.2.2.4.2 BREAKOUTS

Where RFI backshells with individual shield grounding provisions are required for multiple shield terminations, RF circuit shields shall be broken out such that no more than 2 inches of wiring is exposed; and, the wiring must be contained within the connector metal backshell covering.

3.2.2.4.3 GROUNDING OF RADIO FREQUENCY CIRCUIT SHIELDS

RF circuit shields shall be structure grounded as often as possible. This requirement can be satisfied by shield grounding to electrically conductive connector backshells at source and load and at any intermediate breakpoints.

3.2.2.4.4 INTERNAL EQUIPMENT SHIELDS

Shields originating and terminating within the same equipment shall be grounded therein.

3.2.2.4.5 GROUNDING

The shield ground shall be as specified in Table 3.2.1.1-1.

3.2.2.5 BRIDGE WIRE ACTUATED DEVICES

Bridge Wire Actuated Devices (BWAD) use the thermal properties of a heated element to perform a discrete function. BWADs can be categorized into two groups: electroexplosive devices and nonexplosive devices. BWAD firing circuits shall be classified RF in terms of shielding for maximum RF circuit protection. All BWAD interface circuits shall use shielded twisted pair wiring treatment with multipoint grounding of shields at source and load. The method of shield termination shall be via peripheral termination at all connector backshells. For routing purposes, the MO cable separation classification of Table 3.2.1.1-1 shall be applied to all BWAD firing circuits.

4.0 QUALITY ASSURANCE PROVISIONS

All quality assurance provisions shall be in accordance with the Space Station Program Quality Assurance Program Requirements as specified in SSP 41173 or equivalent document for International Partner Agencies.

4.1 RESPONSIBILITY FOR INSPECTION

Unless otherwise specified, the supplier is responsible for the performance of all inspection requirements as specified herein. Except as otherwise specified, the supplier may use his own facilities or any commercial laboratory acceptable to NASA or responsible IP agencies. NASA or responsible IP agencies reserves the right to perform any of the inspections set forth in the requirements document where such inspections are deemed necessary to assure supplies or services conform with prescribed requirements.

APPENDIX A ABBREVIATIONS AND ACRONYMS

| | |
|-------|--|
| ac | Alternating Current |
| BWAD | Bridge Wire Actuated Device |
| dc | Direct Current |
| EMC | Electromagnetic Compatibility |
| EME | Electromagnetic Effects |
| EMEEC | Electromagnetic Environment Effects Control |
| EO | Arbitrary nomenclature to define circuit classes |
| HO | Arbitrary nomenclature to define circuit classes |
| k | Thousand |
| kHz | Kilohertz |
| MHz | Megahertz |
| ML | Arbitrary nomenclature to define circuit classes |
| MO | Arbitrary nomenclature to define circuit classes |
| MPG | Multiple Point Ground |
| mV | Millivolt |
| mW | Milliwatt |
| NASA | National Aeronautics and Space Administration |
| RF | Radio Frequency |
| RFI | Radio Frequency Interference |
| RF1 | Radio Frequency Band 1 |
| RF2 | Radio Frequency Band 2 |
| SSP | Space Station Program |
| TW | Twisted |
| TWDS | Twisted Double Shielded |
| TWS | Twisted Shielded |
| V | Volt |

APPENDIX B GLOSSARY

CABLE, ELECTRICAL

Two or more solid or stranded conductors insulated from each other and routed together or enclosed by a common covering; or one conductor enclosed by but insulated from another conductor or a metallic shield.

EQUIPMENT

Any electrical, electronic, or electromechanical device or collection of devices intended to operate as a single unit and to perform a single function. As used herein, equipment includes, but is not limited to, the following: receivers; transmitters; transponders; power supplies; hand tools; processors; test apparatus; and test instruments.

EXTERNAL INTERFACE CIRCUIT

Any circuit connected via electrical cable to another device or piece of equipment which has a secondary common separate from the circuit under consideration and is under the control of, or part of, another subsystem or equipment.

INTERCONNECTING CABLING

Power, control, and signal lines which interface with equipment or subsystems.

SUBSYSTEM

A collection of equipment designed and integrated to perform a single function where in any equipment within the subsystem is not required to function as an individual equipment.

SYSTEM

A collection of equipment, subsystems, skills, and techniques capable of performing or supporting an operational role. A complete system includes related facilities, equipment, subsystems, materials, services, and personnel required for its operation to the degree that it can be considered self-sufficient within its operational environment.

WIRE, ELECTRICAL

A single current-carrying conductor of one or more strands covered with a suitable insulating material.

APPENDIX C APPROVED TAILORING/INTERPRETATION AGREEMENTS

EMECB TIA-0066

C.3.2.1 CIRCUIT CLASSIFICATION

Exception: The PMA-1 (CI PMA 1 IFCA 3) to NODE 1 (CI NODE 1 IFCA 3) unbraided lines that interface Resistance Temperature Devices (RTD) to the Multiplexer/Demultiplexer (MDM) Low Level Analog (LLA) input terminals will comply with the intent of 3.2.1. While the twisted pair is unshielded by a braid, the shielding function is adequately accomplished by the wire bundle in which the transmission line is installed. The affected cables are: PMA1W0103, PMA1W0104, PMA1W0107, PMA1W0108, PMA1W0303, PMA1W0304, PMA1W0316, PMA1W0317, PMA1W0318, PMA1W0319, PMA1W1303, PMA1W1304, PMA1W1305, PMA1W1306, PMA2W0301, PMA2W0305, PMA2W1301, PMA3W1301, N1W0301, N1W0302, N1W0304, N1W0307, N1W0308, N1W0309, N1W0316, N1W0317, N1W0318, N1W0319, N1W0320, N1W0321, N1W0322, N1W0323, N1W0324, N1W0325, N1W0901, N1W0906, N1W0928, N1W0929, N1W0930, and N1W0933.

Rationale: The intent of the ML classification wire braid is to enhance transmission line interference coupling immunity. The potential interference to these identified sensor transmission lines was studied using mathematical model and confirmed by laboratory test. Interference coupling may be addressed in the following parts:

- a. Bundle crosstalk: The twisted 22 AWG pair is terminated by a balanced and ungrounded resistive load on both the sensor and signal conditioner ends. RTD transmission lines are bundled only with other signal-level transmission lines. The wire pair twisting and the close proximity of the two conductors contribute to provide a transmission line that is relatively immune to the effects of magnetically coupled interference. The signal conditioner LLA is filtered to respond to a differential input of a few tens of hertz only. Both differential and common-mode interference induced by wire bundle crosstalk coupling is so low that it is difficult to measure in the laboratory.
- b. RF Electromagnetic field coupled interference: Differential mode RF field induced voltage is low due to the conductor close spacing as well as the wire twisting effect. The LLA input filter further attenuates any coupled RF current. An unprotected twisted pair exposed to a high level impinging field (RS03) may exhibit a common-mode RF induced voltage of less than one volt peak to peak typically but may rise to as much as ten volts peak to peak at line resonance appearing equally on the two LLA input terminals. Placing the twisted pair in its bundle reduces the induced common-mode voltage to a small fraction of this voltage. The effect of this common-mode voltage is to produce an LLA output signal offset. This offset is not an input signal distortion but a more indirect effect of the LLA signal conditioner's response to an unexpected common mode voltage. Investigation has shown that the inherent field coupling attenuation provided by the wire bundle is more than sufficient to prevent the common-mode voltage output error.

EMECB TIA-0086**C.3.2.2.4.1 Terminations**

Exception: The Stage 2A 1553 data bus shield pigtails that are in the 90 degree connectors comply with the intent of the 3.2.2.4.1 requirement to have a length of 3 inches or less and do not need to be reworked. The connector numbers are as follows:

NZGA-JG-15-N-12
 NZGA-JG-13-N-12Z
 NZGA-JG-13-N-20Z
 NZGA-JG-11-N-12Z
 NZGA-JG-15-N-16Z
 NZGA-JG-11-N-16
 NZGA-JG-25-N-44Z

Rationale: Developmental tests at Huntsville, Test Report D684-10265-01, concentrated on 1553 data bus systems, demonstrated that 1553 data buses are robust to spec-level free-field and induced pulse environments even with purposely degraded shields, including open shields, which represent worse cases than 6-inch shield pigtails.

Therefore, the Stage 2A 1553 data bus pigtails are acceptable as installed and do not need to be reworked.

EMECB TIA-0087**C.3.2.1.1 Frequency or Rise/Fall Time**

Exception: The unshielded Stage 2A RTD-to-LLA wires in the inboard truss cables comply with the intent of 3.2.1 and do not require braid shields. Affected cables are shown in Table C3.2.1.1-1.

**TABLE C.3.2.1.1-1 UNSHIELDED STAGE 2A RTD-TO-LLA WIRES
 (PAGE 1 OF 3)**

| Ref. Des | Qty | Harness Assy Drawing Number | Rev Letter (3) | Wire List Drawing Number | Rev Letter |
|----------|-----|-----------------------------|----------------|--------------------------|------------|
| W4107 | 1 | 1F75180-1 | A | 1F75181-1 | A |
| W4139 | 1 | 1F75514-1 | (B) | 1F75515-1 | N |
| W4154 | 1 | 1F75342-1 | B | 1F75343-1 | C |
| W4155 | 1 | 1F75344-1 | (C) | 1F75345-1 | (D) |
| W4157 | 1 | 1F76506-1 | A | 1F76507-1 | B |
| W4158 | 1 | 1F76508-1 | A | 1F76509-1 | B |
| W4164 | 1 | 1F75538-1 (1F77165-3) | A | 1F75539-1 | A |

**TABLE C.3.2.1.1-1 UNSHIELDED STAGE 2A RTD-TO-LLA WIRES
(PAGE 2 OF 3)**

| Ref. Des | Qty | Harness Assy Drawing Number | Rev Letter (3) | Wire List Drawing Number | Rev Letter |
|----------|-----|---|----------------------|-----------------------------|---------------|
| W4165 | 1 | 1F75540-1 (1F77165-5) | A | 1F75541-1 | A |
| W4167 | 1 | 1F75546-1 (1F77165-7) | A | 1F75547-1 | A |
| W4306 | 1 | 1F75584-1 | A | 1F75585-1 | B |
| W4208 | 1 | 1F75588-1 | (A) | 1F75589-1 | A |
| W4211 | 1 | 1F75594-1 | (A) | 1F75595-1 | (A) |
| W4212 | 1 | 1F75596-1 | (A) | 1F75597-1 | (A) |
| W4301 | 1 | 1F75612-1 | A | 1F75613-1 | A |
| W4302 | 1 | 1F75614-1 | A | 1F75615-1 | A |
| W4303 | 1 | 1F75616-1 | (A) | 1F75617-1 | New |
| W4304 | 1 | 1F75618-1 | New | 1F75619-1 | New |
| W4305 | 1 | 1F75620-1 | A | 1F75621-1 | A |
| W4306 | 1 | 1F75622-1 | A | 1F75623-1 | A |
| W4307 | 1 | 1F75624-1 | (B) | 1F75625-1 | (B) |
| W4308 | 1 | 1F75626-1 | New | 1F75627-1 | New |
| W4312 | 1 | 1F75630-1 | New | 1F75631-1 | New |
| W4313 | 1 | 1F75632-1 | B | 1F75633-1 | B |
| W4314 | 1 | 1F75634-1 | B | 1F75635-1 | A |
| W4316 | 1 | 1F76202-1 (1F77165-9) (1F77165-9) | A | 1F76203-1 | A |
| W4317 | NA | 1F77165-11 | Instl | 1F76573-1 | New |
| W4318 | NA | 1F77165-13 | Instl | 1F76575-1 | New |
| W4321 | NA | 1F77165-15 | Instl | 1F76581-1 | New |
| W4325 | NA | 1F77165-21 | Instl | 1F76589-1 | New |
| W4326 | NA | 1F77165-23 | Instl | 1F76591-1 | New |
| W4327 | NA | 1F77165-25 | Instl | 1F76593-1 | New |
| W4328 | NA | 1F77165-27 | Instl | 1F76595-1 | New |
| W4502 | 1 | 1F75666-1 | A | 1F75667-1 | A |
| W4503 | 1 | 1F75668-1 | A | 1F75669-1 | A |
| W9104 | 1 | 1F75060-1 | (C) | 1F75061-1 | (C) |
| W9141 | 1 | 1F75074-1 | (B) | 1F75075-1 | (C) |
| W9321 | 1 | 1F75100-1 | B | 1F75101-1 | B |
| W9322 | 1 | 1F75102-1 | B | 1F75103-1 | B |

**TABLE C.3.2.1.1-1 UNSHIELDED STAGE 2A RTD-TO-LLA WIRES
(PAGE 3 OF 3)**

| Ref. Des | Qty | Harness Assy Drawing Number | Rev Letter (3) | Wire List Drawing Number | Rev Letter |
|----------|-----|--------------------------------|----------------------|-----------------------------|---------------|
| W9371 | NA | 1F75818-5 | Instl | 1F75065-1 | New |
| W9372 | NA | 1F75817-5 | Instl | 1F76451-1 | New |

Rationale: The intent of the ML wire braid classification and the ensuing braid shields is to reduce EM interference.

Stage 2A designs sufficiently reduce RTD-to-LLA EM interferences of concern and these designs were verified by the MDM qualification tests and a recent developmental test.

These designs and test results are summarized below.

Designs Sufficiently Reduce Common-Mode Interference:

The RTD-to-LLA pairs contained within the in-board truss cables are co-bundled with multiple conductors which in effect shield the RTD-to-LLA pairs from external EM fields, reducing their common-mode interference to acceptable levels.

Designs Sufficiently Reduce Differential-Mode Interference:

Several design features reduce differential-mode interference due to external EM fields on RTD-to-LLA pairs to acceptable levels.

First, the RTD-to-LLA pairs are twisted wires with the conductors in close proximity to one another which significantly reduces magnetically coupled interference. Second, they are terminated by balanced and ungrounded resistive loads on both sensor and signal conditioner ends reducing differential-mode interference. Third, RTD-to-LLA transmission lines are bundled only with other signal-level transmission lines. Fourth, LLA signal conditioners are filtered to respond to differential inputs of only a few tens of Hertz which further attenuates coupled RF interference.

Designs Sufficiently Reduce Bundle Crosstalk:

Several of the designs discussed above reduce bundle crosstalk. In addition, the LLA signal conditioner filters, passing differential inputs of only a few tens of Hertz, significantly reduce frequency-dependent bundle crosstalk.

These designs reduce bundle crosstalk to acceptable levels.

MDM Qualification Tests Verified Designs:

Passed MDM RS03 qualification tests with the RTD-to-LAA pairs unshielded, as they are installed on Stage 2A.

Boeing - Huntington Beach Test Verified Designs:

A recent developmental test, focusing on RTD-to-LLA interfaces, demonstrated RTD-to-LLA interfaces are robust as installed.

This test was conducted during April 7-9, 1998, using flight-like wire harnesses interfacing with an MDM from Honeywell. The interfacing wire harnesses were configured in the screen room to simulate their Stage 2A configuration. This included two loops. The effects of on-orbit electromagnetic fields were simulated by simultaneously illuminating (radiating) both loops and the MDM at the ISS RS03 spec levels, from 10 kHz to 15 GHz. No anomalies were observed. Thereafter, the illumination levels were increased to three times the spec level from 10 kHz to 200 MHz, and twice the specification levels from 200 MHz to 1 GHz. Again, no anomalies were observed.

EMECB TIA-0113**C.3.2.2.2 Implementation of Coding and Bundling and****C.3.2.2.3.2 Separation Requirements**

Exception: The ECOMM GFE Project and Boeing - Houston are allowed to install cabling into Node 1 that only partially meets the intent of 3.2.2.2 and 3.2.2.3.2, as depicted in SSP 684-10276, "Early Communications System Interface Control Drawing," Figure 10A, "Cable Layout." (Also see Boeing -HB Drawing 1F00308, "Patch Installation, Velcro - Node 1)

Rationale: Practical cable layout/runs in the Node, along with assembly-mission, early-ingress IVA considerations, and 2A flight crew preferences for cable bundling/routing preclude the possibility of complete cabling separation into like functions/classifications. All of the cables are shielded and this provides the electromagnetic shielding required. There were no anomalies noted during KSC Cargo Element 2A Testing in this configuration (May 18-20, 1998).